

## BATTERY-BACKUP SUPERVISOR FOR RAM RETENTION

### FEATURES

- Supply Current of 40  $\mu$ A (Max)
- Battery Supply Current of 100 nA (Max)
- Precision 5-V Supply Voltage Monitor, Other Voltage Options on Request
- Backup-Battery Voltage Can Exceed  $V_{DD}$
- Watchdog Timer With 800-ms Time-Out
- Power-On Reset Generator With Fixed 100-ms Reset Delay Time
- Voltage Monitor for Power-Fail or Low-Battery Monitoring
- Battery Freshness Seal (TPS3617 Only)
- 8-Pin MSOP Package
- Temperature Range:  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$

### APPLICATIONS

- Fax Machines
- Set-Top Boxes
- Advanced Voice Mail Systems
- Portable Battery Powered Equipment
- Computer Equipment
- Advanced Modems
- Automotive Systems
- Portable Long-Time Monitoring Equipment
- Point-of-Sale Equipment

### DESCRIPTION

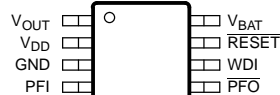
The TPS3617 and TPS3618 are battery-backup supervisors that monitor 5 V supplies. They provide a battery-backup function ideal for applications that require data retention of CMOS RAM during fault conditions. When the voltage at  $V_{DD}$  drops below a preset threshold ( $V_{IT}$ ), the active low push-pull  $\overline{\text{RESET}}$  output asserts, and  $V_{OUT}$  switches from  $V_{DD}$  to  $V_{BAT}$ . When  $V_{DD}$  rises above the trip threshold,  $V_{OUT}$  switches immediately from  $V_{BAT}$  to  $V_{DD}$ . The  $\overline{\text{RESET}}$  output remains low until the delay time ( $t_d$ ) expires. During power on,  $\overline{\text{RESET}}$  is asserted when the supply voltage ( $V_{DD}$  or  $V_{BAT}$ ) goes higher than 1.1 V.

The PFI and  $\overline{\text{PFO}}$  pins are provided if additional voltage monitoring is needed. If the voltage at PFI is less than 1.15 V, the push-pull  $\overline{\text{PFO}}$  pin will assert low. When the voltage at PFI exceeds the threshold voltage,  $\overline{\text{PFO}}$  will go high.

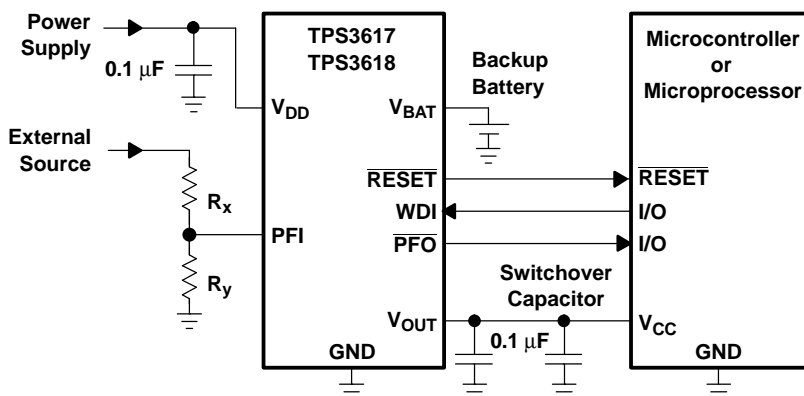
These devices also feature a watchdog timer pin (WDI) that monitors processor activity and asserts  $\overline{\text{RESET}}$  if the the processor is inactive longer than the watchdog timeout period. If the watchdog timer is not used, the WDI pin should be left floating.

The TPS3617 and TPS3618 are available in an 8-pin MSOP package and are characterized for operation over a temperature range of  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

MSOP (DGK) Package  
(TOP VIEW)



ACTUAL SIZE  
3,05 mm x 4,98 mm



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

**PACKAGE INFORMATION<sup>(1)</sup>**

PRODUCT	NOMINAL SUPPLY VOLTAGE	THRESHOLD VOLTAGE (V <sub>IT</sub> ) <sup>(2)</sup>	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA, QUANTITY
TPS3617-50	5V	4.55V	-40°C to +125°C	ASD	TPS3617-50DGK	Tube, 80
					TPS3617-50DGKR	Tape and Reel, 2500
TPS3618-50				ANK	TPS3618-50DGKT	Tape and Reel, 250
					TPS3618-50DGKR	Tape and Reel, 2500

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this data sheet, or refer to our web site at [www.ti.com](http://www.ti.com).  
 (2) For other threshold voltages, contact the local TI sales office for availability and lead time.

**ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

	TPS3617, TPS3618	UNIT
Input voltage range, $V_{DD}$	-0.3 to 7	V
Input voltage range, PFI pin	-0.3 to ( $V_{DD} + 0.3$ )	V
Continuous output current at $V_{OUT}$ , $I_O$	400	mA
All other pins, $I_O$	±10	mA
Operating junction temperature range, $T_J$ <sup>(2)</sup>	-40 to +85	°C
Storage temperature range, $T_{STG}$	-65 to +150	°C
Lead temperature soldering 1,6 mm (1/16 inch) from case for 10 seconds	+260	°C
Continuous total power dissipation	See Dissipation Rating Table	

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.  
 (2) Due to the low dissipated power in this device, it is assumed that  $T_J = T_A$ .

**DISSIPATION RATING TABLE**

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING
DGK	470 mW	3.76 mW/°C	301 mW	241 mW

## ELECTRICAL CHARACTERISTICS

1.65 V ≤ V<sub>DD</sub> ≤ 5.5 V, R<sub>LRESET</sub> = 1 MΩ, C<sub>LRESET</sub> = 50 pF, over operating temperature range (T<sub>J</sub> = -40°C to +85°C), unless otherwise noted. Typical values are at T<sub>J</sub> = 25°C.

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>DD</sub>	Input supply range			1.65		5.5	V
I <sub>DD</sub>	V <sub>DD</sub> supply current	V <sub>OUT</sub> = V <sub>DD</sub>				40	μA
		V <sub>OUT</sub> = V <sub>BAT</sub>				40	
V <sub>BAT</sub>	Battery supply range			1.5		5.5	V
I <sub>BAT</sub>	V <sub>BAT</sub> supply current	V <sub>OUT</sub> = V <sub>DD</sub>		-0.1		0.1	μA
		V <sub>OUT</sub> = V <sub>BAT</sub>				0.5	
	Slew rate at V <sub>DD</sub> or V <sub>BAT</sub>					1	V/μs
V <sub>I</sub>	Input voltage, any input			0		V <sub>DD</sub> + 0.3	V
V <sub>OH</sub>	High-level output voltage	RESET	V <sub>DD</sub> = 1.8 V, I <sub>OH</sub> = -400 μA			V <sub>DD</sub> - 0.2	V
			V <sub>DD</sub> = 3.3 V, I <sub>OH</sub> = -2 mA, V <sub>DD</sub> = 5 V, I <sub>OH</sub> = -3 mA			V <sub>DD</sub> - 0.4	
		PFO	V <sub>DD</sub> = 1.8 V, I <sub>OH</sub> = -20 μA			V <sub>DD</sub> - 0.3	
			V <sub>DD</sub> = 3.3 V, I <sub>OH</sub> = -80 μA, V <sub>DD</sub> = 5 V, I <sub>OH</sub> = -120 μA			V <sub>DD</sub> - 0.4	
V <sub>OL</sub>	Low-level output voltage	RESET PFO	V <sub>DD</sub> = 1.8 V, I <sub>OL</sub> = 400 μA			0.2	V
			V <sub>DD</sub> = 3.3 V, I <sub>OL</sub> = 2 mA, V <sub>DD</sub> = 5 V, I <sub>OL</sub> = 3 mA			0.4	
V <sub>RES</sub>	Power-up reset voltage <sup>(1)</sup>		V <sub>BAT</sub> > 1.1 V, or V <sub>DD</sub> > 1.1 V, I <sub>OL</sub> = 20 μA			0.4	V
V <sub>OUT</sub>	Normal mode		I <sub>O</sub> = 8.5 mA, V <sub>DD</sub> = 1.8 V, V <sub>BAT</sub> = 0 V			V <sub>DD</sub> - 0.050	V
			I <sub>O</sub> = 125 mA, V <sub>DD</sub> = 3.3 V, V <sub>BAT</sub> = 0 V			V <sub>DD</sub> - 0.150	
			I <sub>O</sub> = 200 mA, V <sub>DD</sub> = 5 V, V <sub>BAT</sub> = 0 V			V <sub>DD</sub> - 0.200	
	Battery-backup mode		I <sub>O</sub> = 0.5 mA, V <sub>BAT</sub> = 1.5 V, V <sub>DD</sub> = 0 V			V <sub>BAT</sub> - 0.200	
			I <sub>O</sub> = 7.5 mA, V <sub>BAT</sub> = 3.3 V, V <sub>DD</sub> = 0 V			V <sub>BAT</sub> - 0.113	
R <sub>DS(on)</sub>	V <sub>DD</sub> to V <sub>OUT</sub> on-resistance		V <sub>DD</sub> = 5 V		0.6	1	Ω
	V <sub>BAT</sub> to V <sub>OUT</sub> on-resistance		V <sub>BAT</sub> = 3.3 V		8	15	
I <sub>O</sub>	Continuous output current at V <sub>OUT</sub>					300	mA
V <sub>IT</sub>	Negative-going input threshold voltage <sup>(2)</sup>	TPS3617-50	T <sub>A</sub> = -40°C to 85°C	4.46	4.55		V
V <sub>PFI</sub>		PFI		1.13	1.15	1.17	V
V <sub>HYS</sub>	V <sub>IT</sub> hysteresis		1.65 V < V <sub>IT</sub> < 2.5 V		20		mV
			2.5 V < V <sub>IT</sub> < 3.5 V		40		
			3.5 V < V <sub>IT</sub> < 5.5 V		60		
	PFI hysteresis				12		
	V <sub>BSW</sub> hysteresis <sup>(3)</sup>		V <sub>DD</sub> = 1.8 V		55		
V <sub>IH</sub>	WDI high-level input voltage			0.7 × V <sub>DD</sub>			
V <sub>IL</sub>	WDI low-level input voltage				0.3 × V <sub>DD</sub>		
I <sub>IH</sub>	WDI high-level input current <sup>(4)</sup>		WDI = V <sub>DD</sub> = 5 V			150	μA
I <sub>IL</sub>	WDI low-level input current <sup>(4)</sup>		WDI = 0 V, V <sub>DD</sub> = 5 V			-150	μA
	WDI input transition rise and fall rate, Δt/ΔV					100	ns/V
I <sub>I</sub>	PFI input current		PFI voltage < V <sub>DD</sub>	-25		25	nA
I <sub>OS</sub>	PFO short-circuit current		PFO = 0 V, V <sub>DD</sub> = 1.8 V			-0.3	mA
			PFO = 0 V, V <sub>DD</sub> = 3.3 V			-1.1	
			PFO = 0 V, V <sub>DD</sub> = 5 V			-2.4	

(1) The lowest supply voltage at which RESET becomes active. t<sub>r</sub>, V<sub>DD</sub> ≥ 15 μs/V.

(2) To ensure the best stability of the threshold voltage, a bypass capacitor (ceramic, 0.1 μF) should be placed near the supply terminals.

(3) For V<sub>DD</sub> < 1.6 V, V<sub>OUT</sub> switches to V<sub>BAT</sub> regardless of V<sub>BAT</sub>.

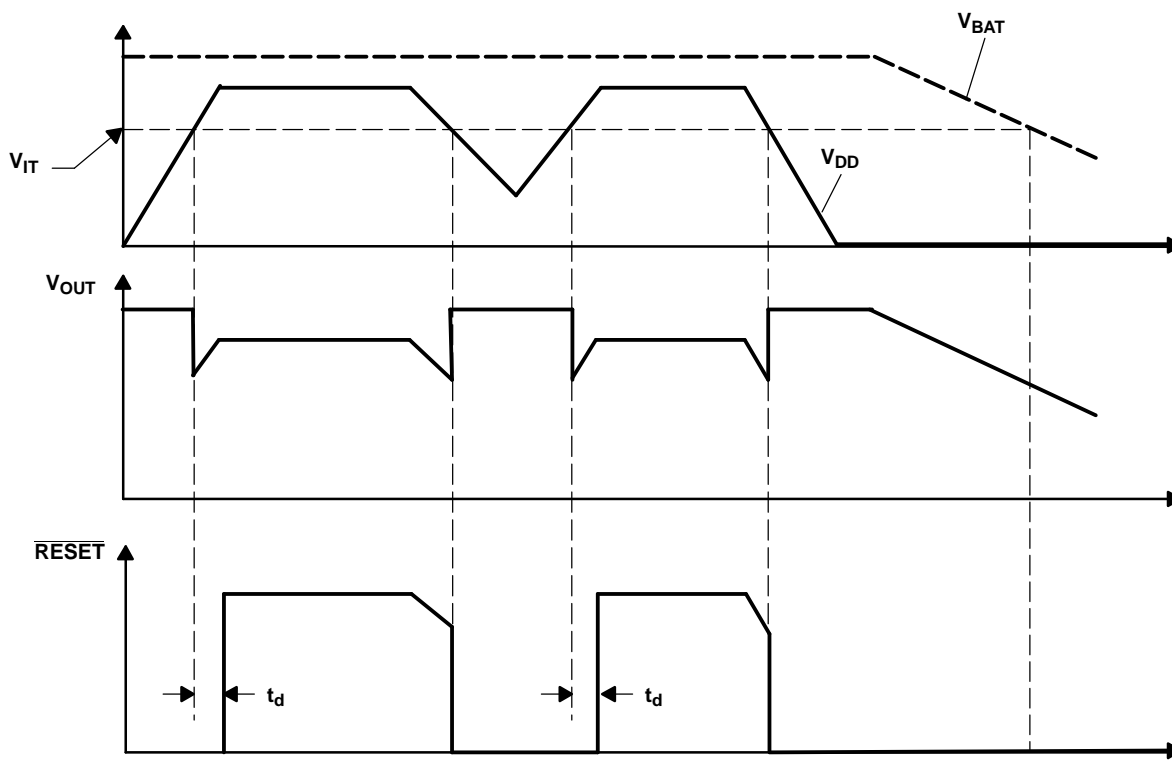
(4) For details on how to optimize current consumption when using WDI, refer to the Watchdog section of this data sheet.

## ELECTRICAL CHARACTERISTICS (continued)

$1.65\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $R_{LRESET} = 1\text{ M}\Omega$ ,  $C_{LRESET} = 50\text{ pF}$ , over operating temperature range ( $T_J = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ), unless otherwise noted. Typical values are at  $T_J = 25^\circ\text{C}$ .

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
C <sub>i</sub>	Input capacitance, any input		V <sub>I</sub> = 0 V to 5 V	5			pF
t <sub>w</sub>	Pulse Width	V <sub>DD</sub>	V <sub>IH</sub> = V <sub>IT</sub> + 0.2 V, V <sub>IL</sub> = V <sub>IT</sub> - 0.2 V	6			μs
		WDI	V <sub>DD</sub> > V <sub>IT</sub> + 0.2 V, V <sub>IL</sub> = 0.3 x V <sub>DD</sub> , V <sub>IH</sub> = 0.7 x V <sub>DD</sub>	100			ns
t <sub>d</sub>	Delay time		V <sub>DD</sub> ≥ V <sub>IT</sub> + 0.2 V, See timing diagram	60	100	140	ms
t <sub>(tout)</sub>	Watchdog time-out		V <sub>DD</sub> > V <sub>IT</sub> + 0.2 V, See timing diagram	0.48	0.8	1.12	s
t <sub>PHL</sub>	Propagation (delay) time, high-to-low-level output	V <sub>DD</sub> to $\overline{\text{RESET}}$	V <sub>IL</sub> = V <sub>IT</sub> - 0.2 V, V <sub>IH</sub> = V <sub>IT</sub> + 0.2 V	2      5			μs
		PFI to $\overline{\text{PFO}}$	V <sub>IL</sub> = V <sub>PFI</sub> - 0.2 V, V <sub>IH</sub> = V <sub>PFI</sub> + 0.2 V	3      5			
Transition time		V <sub>DD</sub> to V <sub>BAT</sub>		3			μs

## TIMING DIAGRAM



## FUNCTION TABLE

$V_{DD} > V_{IT}$	$V_{DD} > V_{BAT}$	$V_{OUT}$	$\overline{\text{RESET}}$
0	0	$V_{BAT}$	0
0	1	$V_{DD}$	0
1	0	$V_{DD}$	1
1	1	$V_{DD}$	1

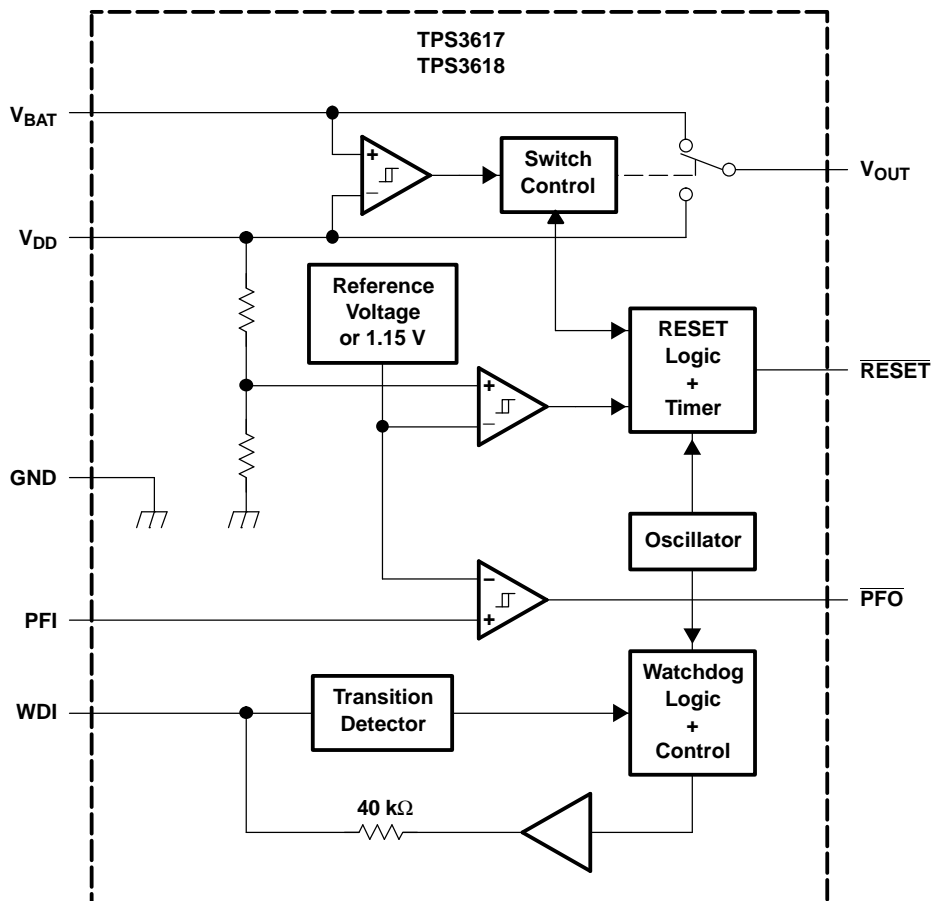
### PFO FUNCTION TABLE

$PFI > V_{PFI}$	$\overline{PFO}$
0	0
1	1
CONDITION: $V_{DD} > V_{DD(MIN)}$	

### TERMINAL FUNCTIONS

TERMINAL NAME	NO.	I/O	DESCRIPTION
GND	3	I	Ground
PFI	4	I	Power-fail comparator input
$\overline{PFO}$	5	O	Power-fail comparator output; asserts low when $PFI < 1.15\text{ V}$
$\overline{\text{RESET}}$	7	O	Active-low push-pull reset output
$V_{BAT}$	8	I	Backup-battery input
$V_{DD}$	2	I	Input supply voltage
$V_{OUT}$	1	O	Supply output
WDI	6	I	Watchdog input. Should be left floating if not used.

### FUNCTIONAL BLOCK DIAGRAM



## TYPICAL CHARACTERISTICS

### TABLE OF GRAPHS

			FIGURE
$r_{DS(on)}$	Static drain-source on-state resistance ( $V_{DD}$ to $V_{OUT}$ )	vs Output current	3
	Static drain-source on-state resistance ( $V_{BAT}$ to $V_{OUT}$ )	vs Output current	4
$I_{DD}$	Supply current	vs Supply voltage	5
$V_{IT}$	Input threshold voltage at $\overline{RESET}$	vs Free-air temperature	6
$V_{OH}$	High-level output voltage at $\overline{RESET}$	vs High-level output current	7, 8
	High-level output voltage at $\overline{PFO}$		9, 10
$V_{OL}$	Low-level output voltage at $\overline{RESET}$	vs Low-level output current	11, 12
	Minimum pulse duration at $V_{DD}$	vs Threshold voltage overdrive at $V_{DD}$	13
	Minimum pulse duration at PFI	vs Threshold voltage overdrive at PFI	14

**STATIC DRAIN-SOURCE ON-STATE RESISTANCE**  
( $V_{DD}$  to  $V_{OUT}$ )  
vs  
OUTPUT CURRENT

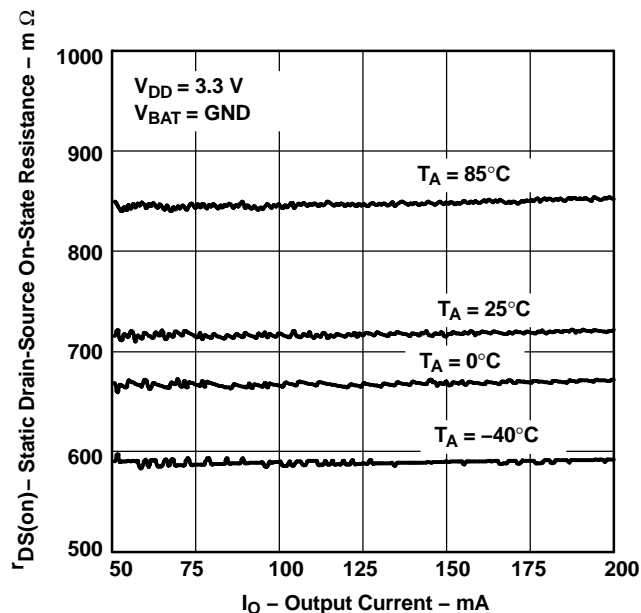


Figure 1.

**STATIC DRAIN-SOURCE ON-STATE RESISTANCE**  
( $V_{BAT}$  to  $V_{OUT}$ )  
vs  
OUTPUT CURRENT

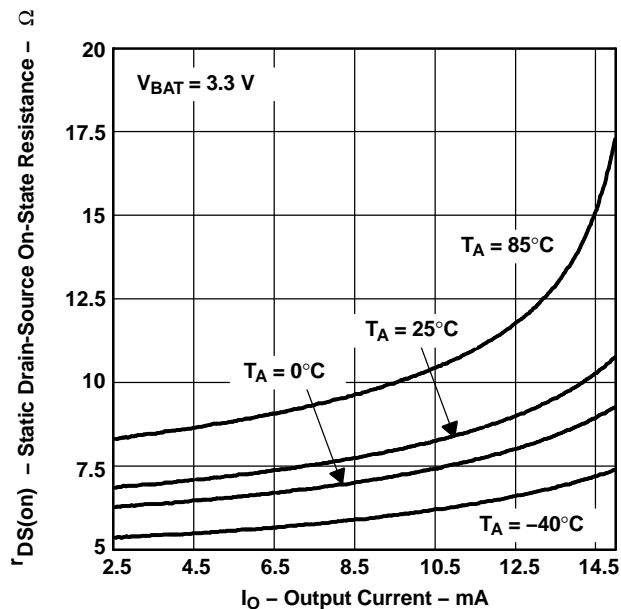


Figure 2.

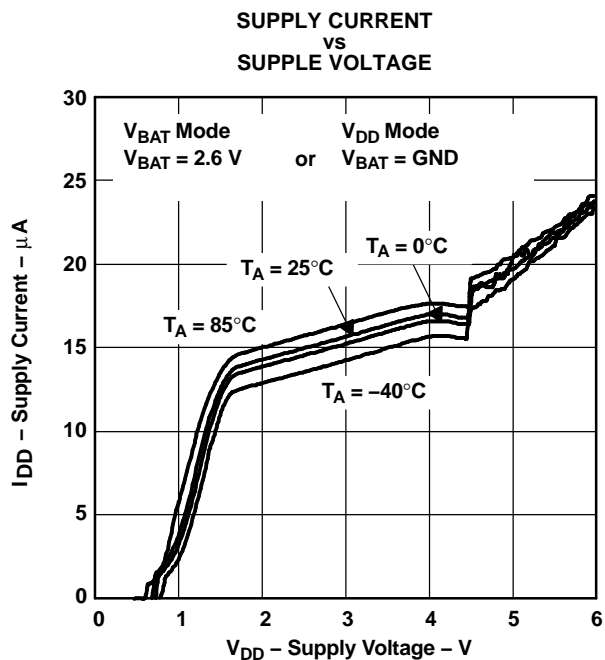


Figure 3.

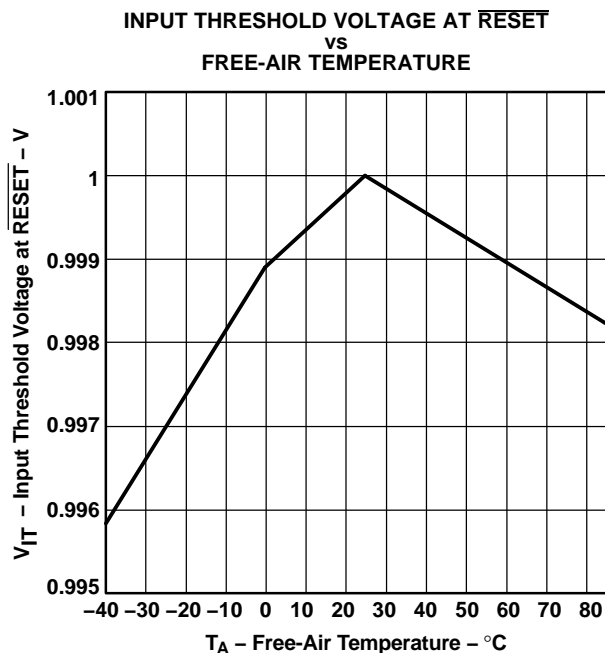


Figure 4.

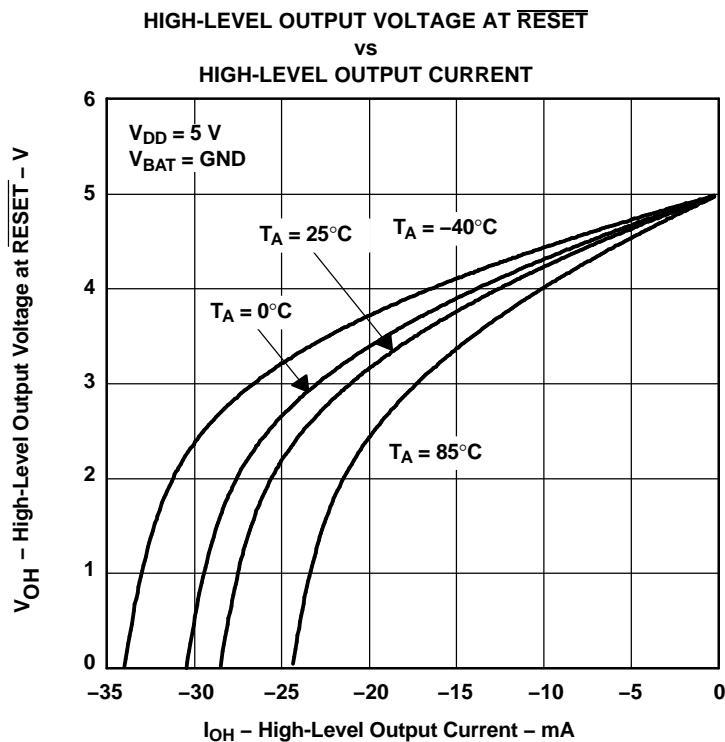


Figure 5.

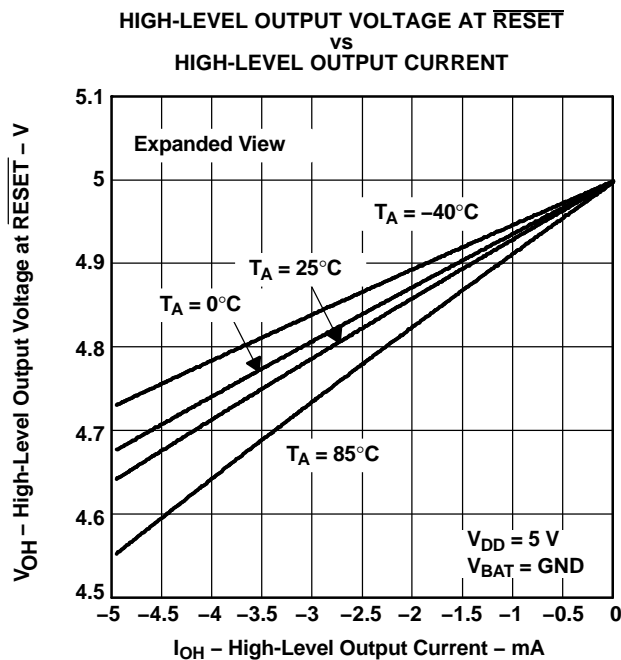


Figure 6.

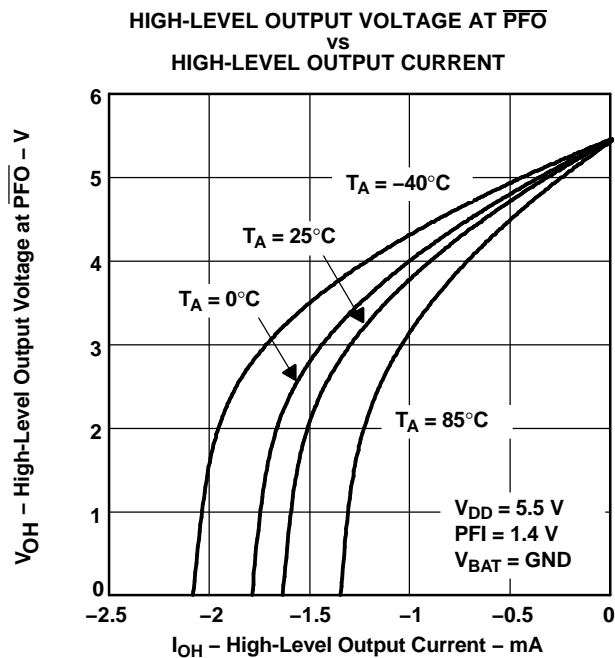


Figure 7.

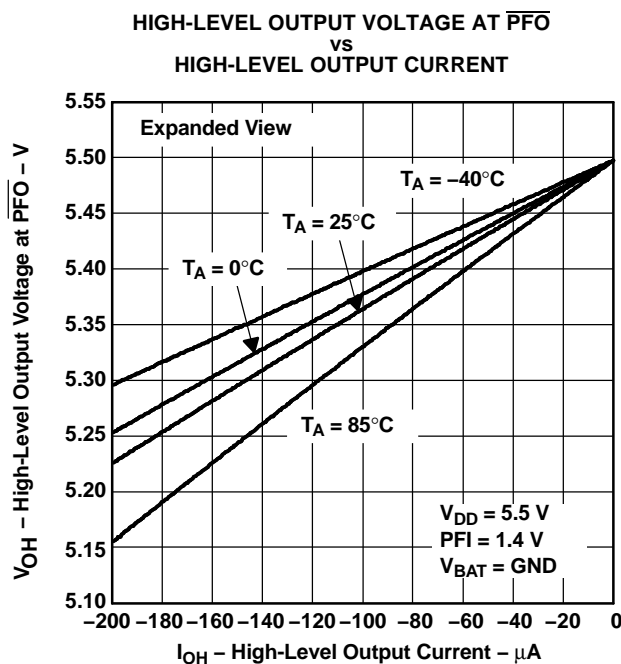


Figure 8.

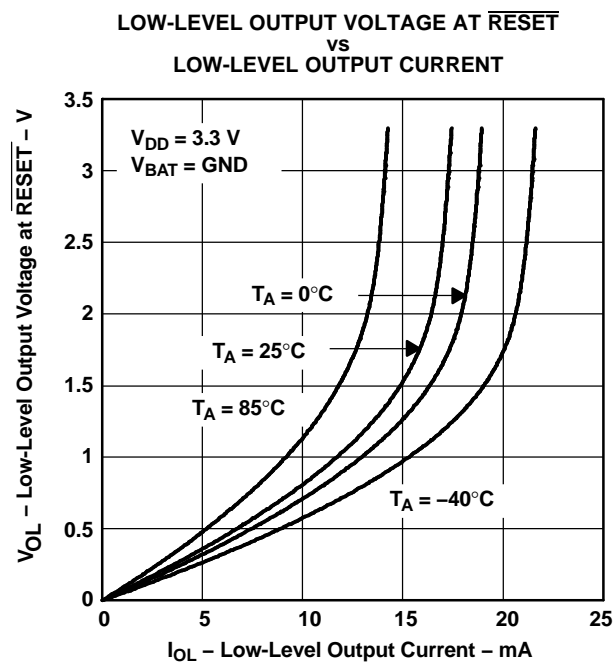


Figure 9.



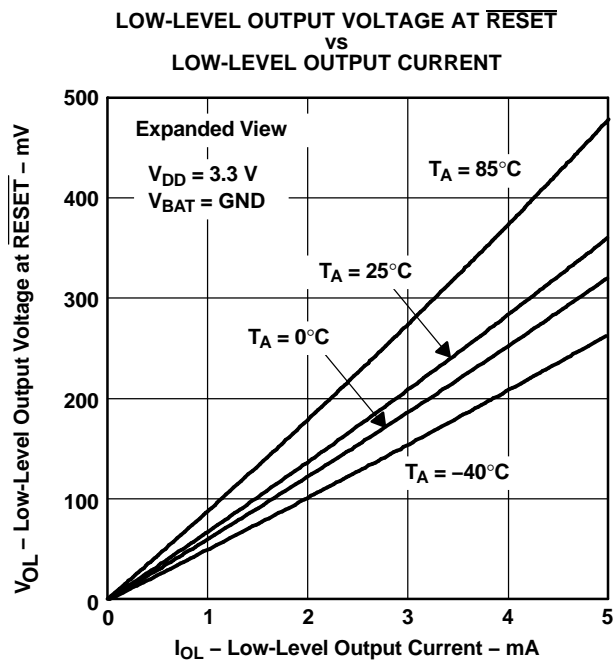


Figure 10.

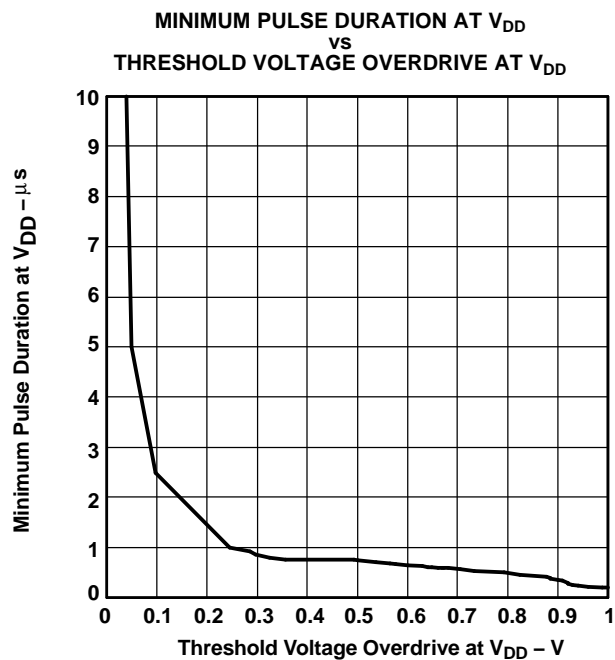


Figure 11.

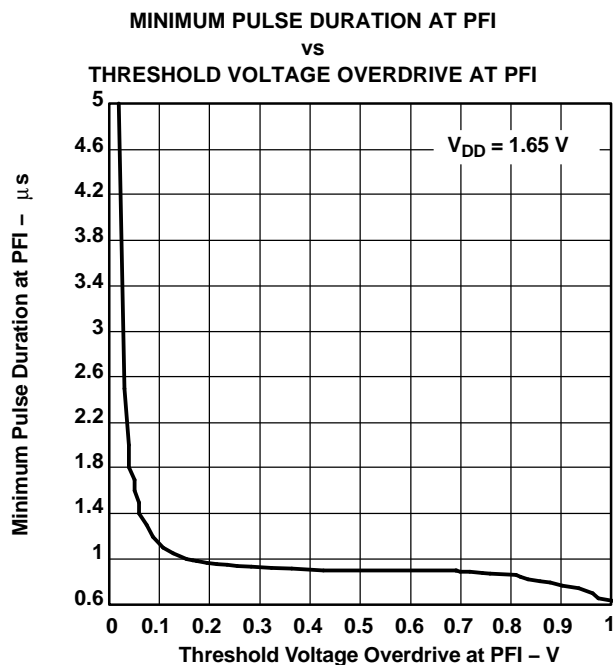


Figure 12.

## DETAILED DESCRIPTION

### BATTERY FRESHNESS SEAL (TPS3617 Only)

The battery freshness seal of the TPS3617 family disconnects the backup battery from the internal circuitry until it is needed. This ensures that the backup battery connected to  $V_{BAT}$  should be fresh when the final product is put to use. The following steps explain how to enable the freshness seal mode:

1. Connect  $V_{BAT}$  ( $V_{BAT} > V_{BAT(min)}$ ).
2. Ground  $\overline{PFO}$ .
3. Connect PFI to  $V_{DD}$  ( $PFI = V_{DD}$ ).
4. Connect  $V_{DD}$  to power supply ( $V_{DD} > V_{IT}$ ) and keep connected for  $5\text{ ms} < t < 35\text{ ms}$ .

The battery freshness seal mode is disabled by the positive-going edge of  $\overline{RESET}$  when  $V_{DD}$  is applied.

### POWER-FAIL COMPARATOR (PFI AND $\overline{PFO}$ )

An additional comparator monitors voltages other than the nominal supply voltage. The power-fail-input (PFI) can be compared with an internal voltage reference of 1.15 V. If the input voltage falls below the power-fail threshold ( $V_{(PFI)}$ ) of 1.15 V typical, the power-fail output ( $\overline{PFO}$ ) goes low. If it goes above  $V_{(PFI)}$  plus about 12-mV hysteresis, the output returns to high. By connecting two external resistors it is possible to supervise any voltages above  $V_{(PFI)}$ . The sum of both resistors should be about 1 M $\Omega$ , to minimize power consumption and also to ensure that the current in the PFI pin can be neglected compared with the current through the resistor network. The tolerance of the external resistors should be not more than 1% to ensure minimal variation of the sensed voltage. If the power-fail comparator is unused, connect PFI to ground and leave the  $\overline{PFO}$  unconnected.

### WATCHDOG

In a microprocessor- or DSP-based system, it is not only important to supervise the supply voltage, it is also important to ensure correct program execution. The task of a watchdog is to ensure that the program is not stalled in an indefinite loop. The microprocessor, microcontroller, or DSP has to toggle the watchdog input within 0.8 s typically, to avoid a timeout from occurring. Either a low-to-high or a high-to-low transition resets the internal watchdog timer. If the input is unconnected, the watchdog is disabled and should be retrigged internally. See Figure 13 for the watchdog timing diagram.

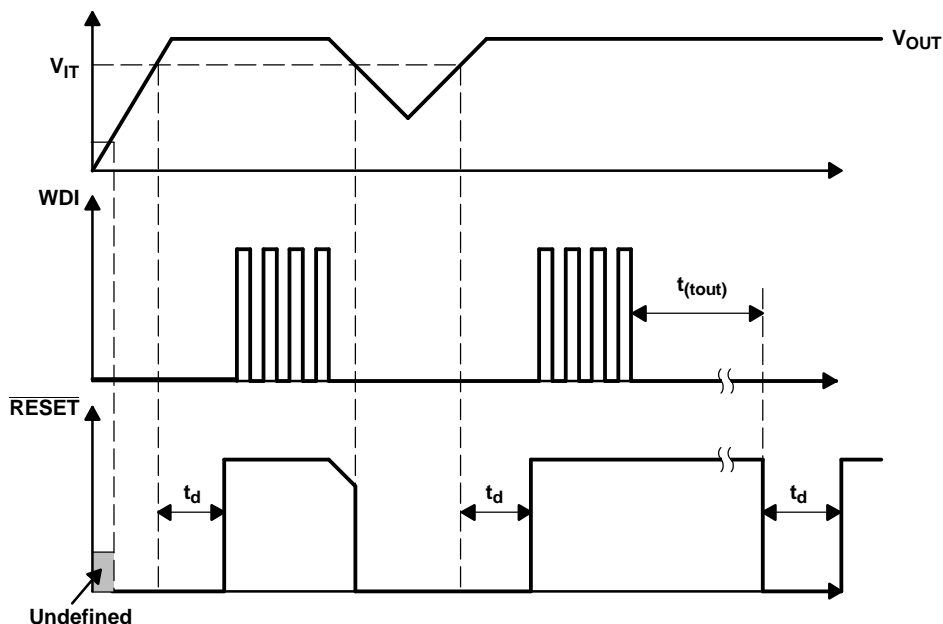


Figure 13. Watchdog Timing



## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TPS3617-50DGK	ACTIVE	MSOP	DGK	8	80	None	CU NIPDAU	Level-1-220C-UNLIM
TPS3617-50DGKR	ACTIVE	MSOP	DGK	8	2500	None	CU NIPDAU	Level-1-220C-UNLIM
TPS3618-50DGKR	ACTIVE	MSOP	DGK	8	2500	None	CU NIPDAU	Level-1-220C-UNLIM
TPS3618-50DGKT	ACTIVE	MSOP	DGK	8	250	None	CU NIPDAU	Level-1-220C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**None:** Not yet available Lead (Pb-Free).

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

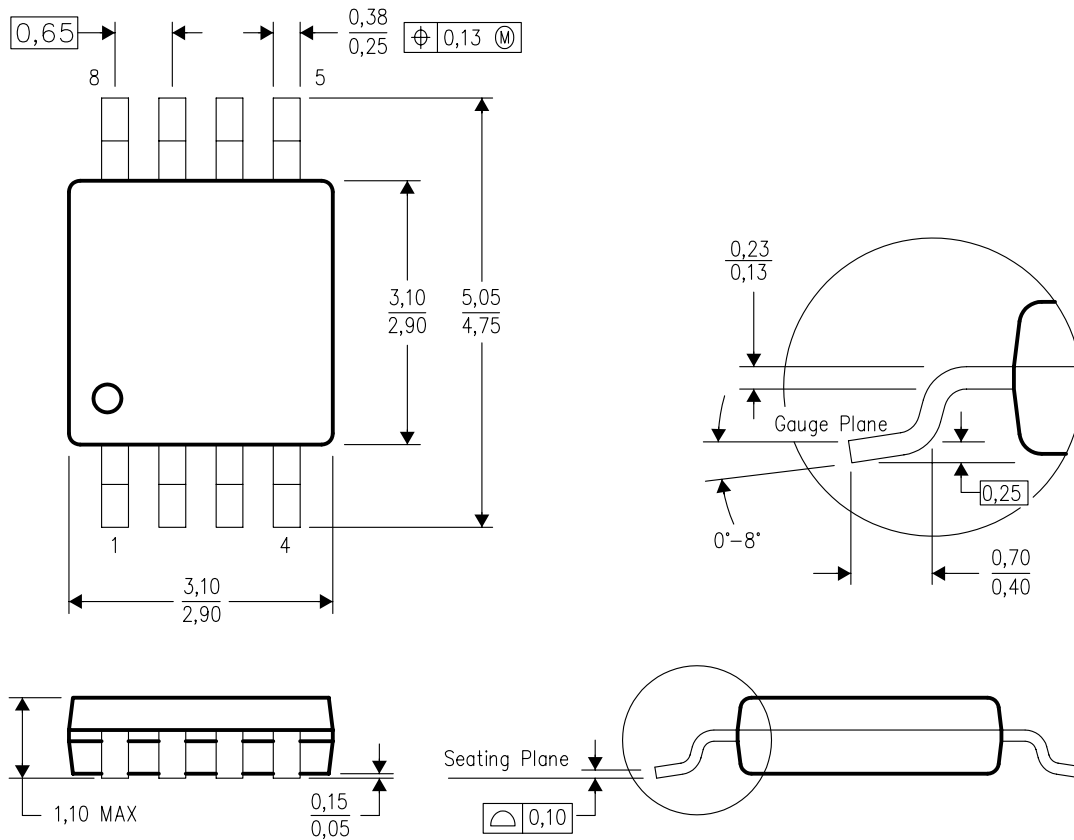
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## DGK (S-PDSO-G8)

## PLASTIC SMALL-OUTLINE PACKAGE



4073329/D 12/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion.
  - D. Falls within JEDEC MO-187 variation AA.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

<b>Products</b>		<b>Applications</b>	
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>	Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>	Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
		Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
		Wireless	<a href="http://www.ti.com/wireless">www.ti.com/wireless</a>

Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated